SURFACE MOUNT

RF Transformer

TC8-1G2+

50Ω 2 to 500 MHz

FEATURES

- Suitable for tin/lead and RoHS solder systems
- Wideband, 2 to 500 MHz
- Good return loss
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: AT224-3

+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

APPLICATIONS

- Push-pull amplifier
- Impedance matching

ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio (secondary/primary)			8		Ohm
Frequency Range		2		500	MHz
Insertion Loss*	2-500		3.0		dB
	5-400		2.0		
	10-100		1.0		

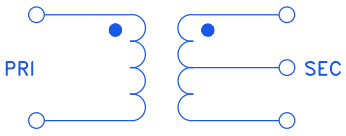
* Insertion Loss is referenced to mid-band loss, 0.8 dB typ.

ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

CONFIG. A



REV. B
ECO-022715
TC8-1G2+
MCL NY
240808

SURFACE MOUNT

RF Transformer

TC8-1G2+

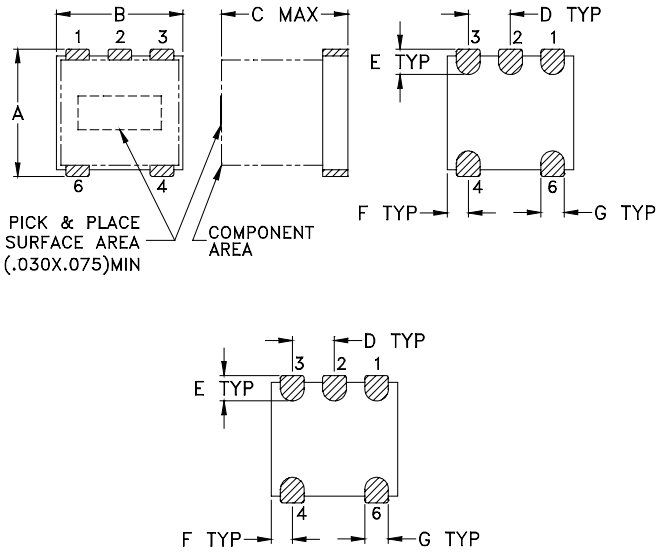
50Ω 2 to 500 MHz

PIN CONNECTIONS

PRIMARY DOT	6
PRIMARY	4
SECONDARY DOT	3
SECONDARY	1
SECONDARY CT	2

PRODUCT MARKING: N/A

OUTLINE DRAWING



OUTLINE DIMENSIONS (Inch / mm)

A	B	C	D	E	F
.150	.150	.150	.050	.030	.025
3.81	3.81	3.81	1.27	0.76	0.64

G	H	J	K	wt
.028	.065	.190	.030	grams
0.71	1.65	4.83	0.76	0.10

TAPE & REEL INFORMATION: F17

SURFACE MOUNT

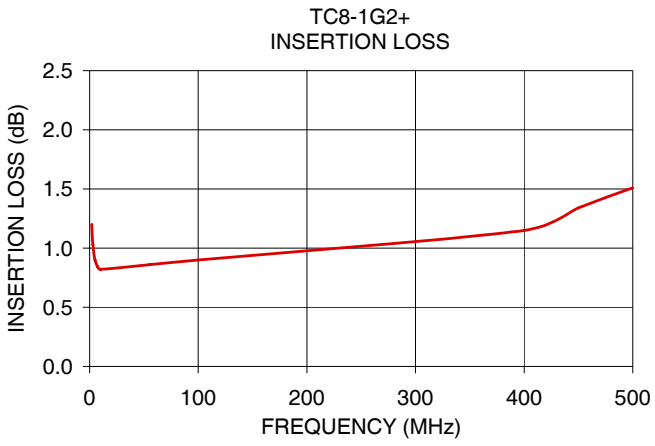
RF Transformer

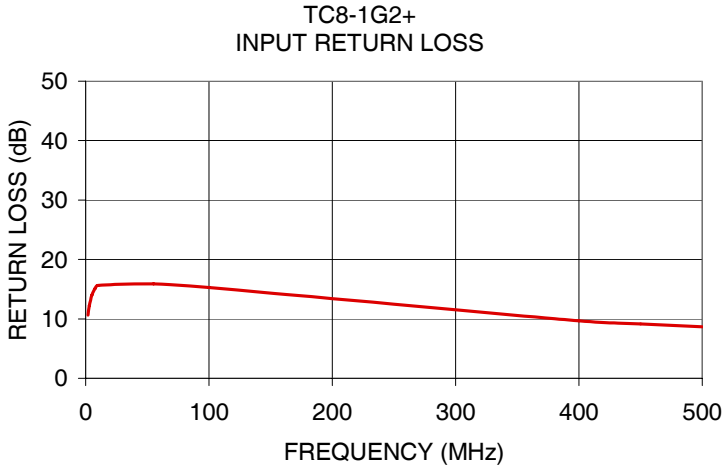
TC8-1G2+

50Ω 2 to 500 MHz

TYPICAL PERFORMANCE DATA

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)
2.00	1.20	10.65
3.00	1.03	12.20
5.00	0.90	14.01
7.50	0.84	15.09
10.00	0.82	15.64
55.00	0.86	15.88
100.00	0.90	15.29
400.00	1.15	9.68
450.00	1.34	9.15
500.00	1.51	8.67





NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

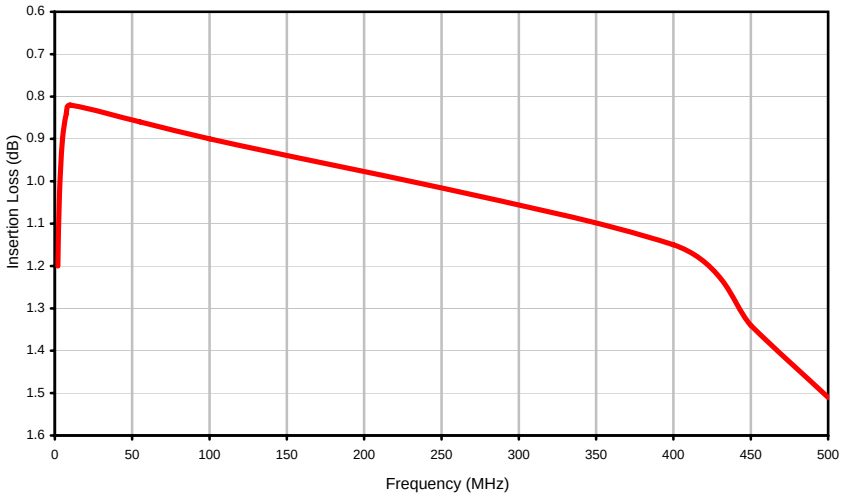
RF Transformer TC8-1G2+

Typical Performance Data

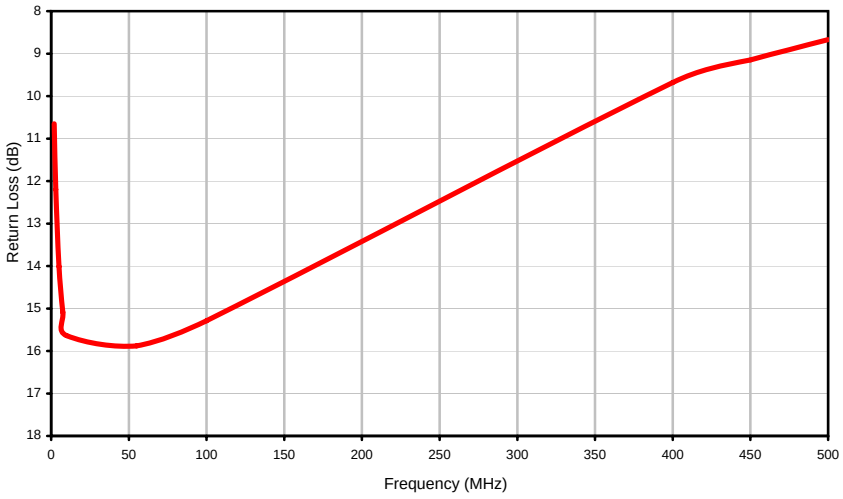
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
2.00	1.20	10.65
3.00	1.03	12.20
5.00	0.90	14.01
7.50	0.84	15.09
10.00	0.82	15.64
55.00	0.86	15.88
100.00	0.90	15.29
400.00	1.15	9.68
450.00	1.34	9.15
500.00	1.51	8.67

Typical Performance Curves

Insertion Loss



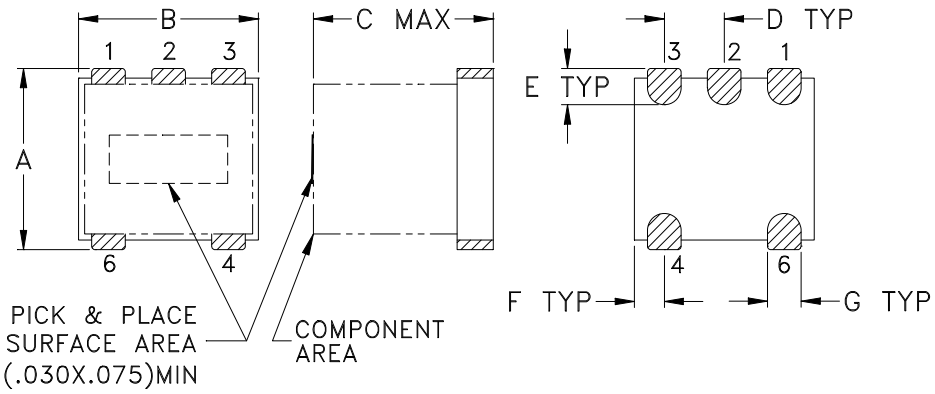
Return Loss



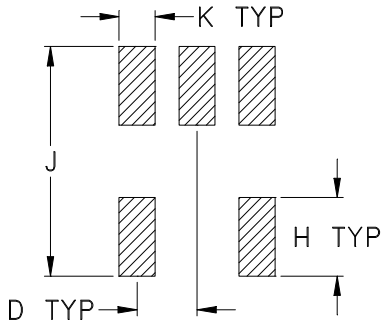
Case Style AT

Outline Dimensions

AT224-3



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT224-3	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	-- --	.10

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

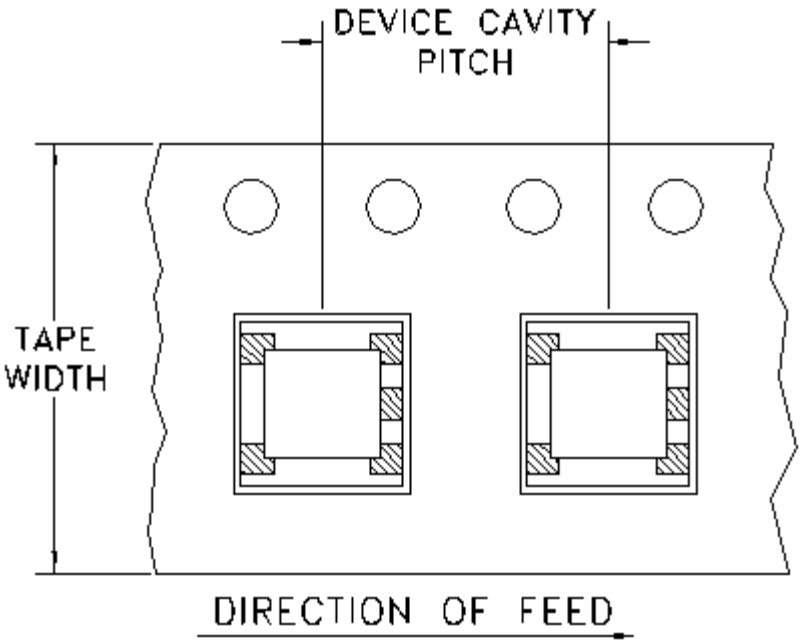
1. Open style, ceramic base.
2. Termination finish: 3.15-5.12 µ inch (.08-.130 microns) Gold over 78–236 µ inch (1.98-6.0 microns) Nickel plate.

Mini-Circuits®
ISO 9001 ISO 14001 CERTIFIED
ALL NEW minicircuits.com
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com
RF/IF MICROWAVE COMPONENTS

This document and its contents are the property of Mini-Circuits.

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

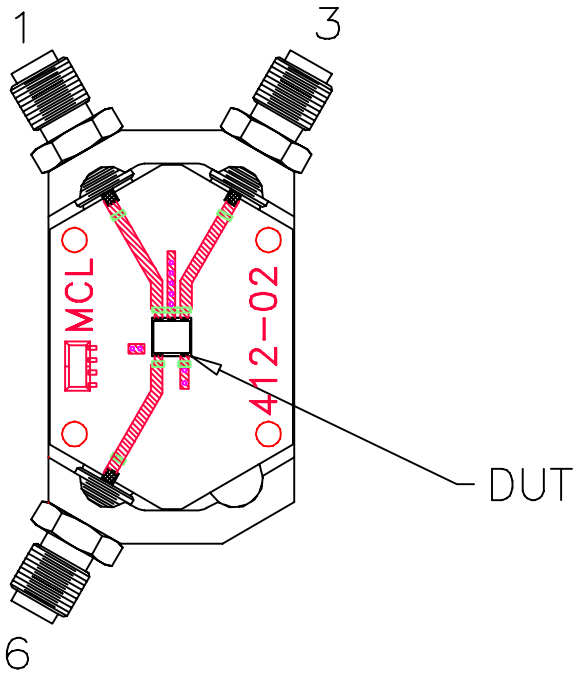
Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

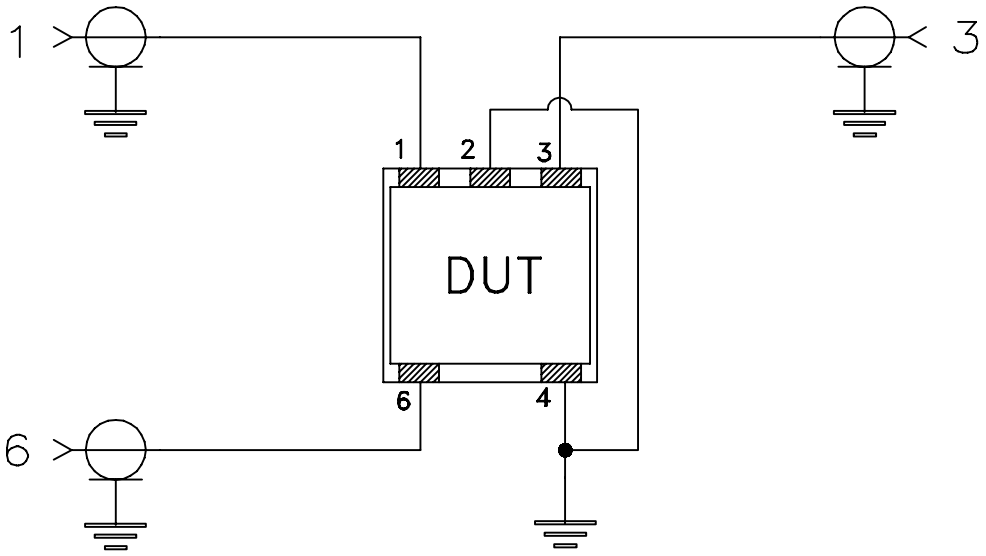
This document and its contents are the property of Mini-Circuits.

Evaluation Board and Circuit

For Pin Connections refer to Data Sheet of the DUT



TB-145



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: Rogers RO4350B or its equivalent, Dielectric Constant=3.5, Thickness=.020"

Mini-Circuits®

THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS.

Mini-Circuits

Environmental Specifications ENV02

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215

This document and its contents are the property of Mini-Circuits.